

P-Channel MOSFET

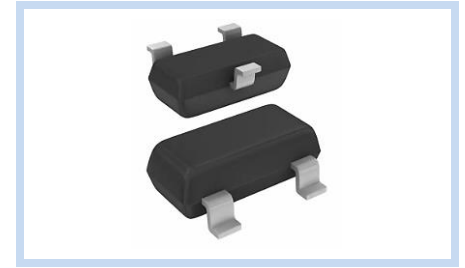
20V 0.5A 0.5W SOT-23 ESD

MFT2PA5S23E

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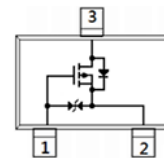
FEATURE

- $R_{DS(ON)} < 1.2\Omega$, $V_{GS} = -4.5V$
- $R_{DS(ON)} < 1.5\Omega$, $V_{GS} = -2.5V$
- Advanced Trench Process technology
- Application: Switch Load, PWN Application, etc
- ESD Protected



MECHANICAL DATA

- Case: SOT-23 Package
- Terminals: Solderable per MIL-STD-750, Method 2026

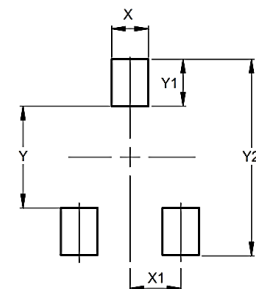
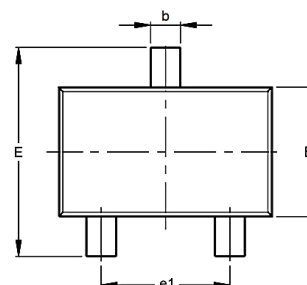
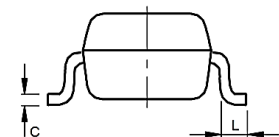
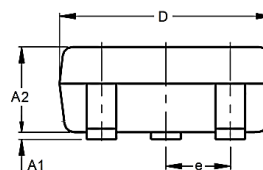


MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	± 10	V
Drain Current – Continuous		I_D	-0.5	A
Drain Current – Pulsed		I_{DM}	-1.0	A
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	0.5	W
	Derate above 25°C		4	mW / $^\circ\text{C}$
Thermal Resistance, Junction to Ambient		$R_{\theta JA}$	250	$^\circ\text{C} / \text{W}$
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

DIMENSIONS

Item	Min (mm)	Max (mm)
A1	0.00	0.10
A2	0.80	1.10
b	0.35	0.50
c	0.08	0.20
D	2.80	3.04
e	0.90	1.00
e1	1.80	2.00
E	2.20	2.60
E1	1.20	1.40
L	0.15	--
X	0.80	--
X1	0.95	
Y	1.10	
Y1	0.90	--
Y2	2.90	



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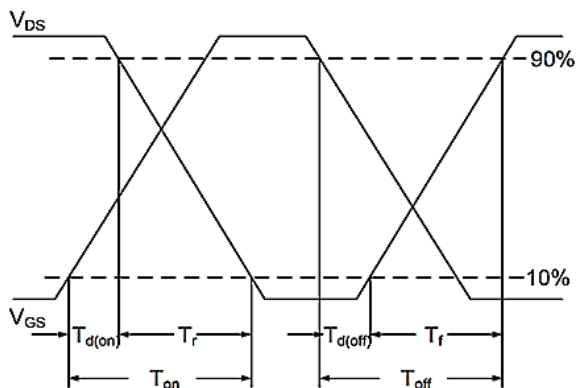
ELECTRICAL CHARACTERISTICS

Off Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D = -250\mu A$	BV_{DSS}	-20	--	--	V
Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D = -250\mu A$	$V_{GS(th)}$	-0.3	-0.59	-1.0	V
Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 8V$	I_{GSS}	--	± 2	± 10	μA
Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS}=0V$	I_{DSS}	--	-0.01	-1	μA
On Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Static Drain-Source On-Resistance	$V_{GS} = -4.5V, I_D = -500mA$	$R_{DS(ON)}$	--	0.85	1.2	Ω
	$V_{GS} = -2.5V, I_D = -200mA$		--	0.98	1.5	
	$V_{GS} = -1.8V, I_D = -100mA$		--	1.15	2.2	
	$V_{GS} = -1.5V, I_D = -50mA$		--	1.33	3.6	
	$V_{GS} = -1.2V, I_D = -10mA$		--	1.5	6.0	
Dynamic Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Input Capacitance	$V_{DS} = -10V, V_{GS} = 0V, F = 1.0MHz$	C_{iss}	--	38	--	pF
Output Capacitance		C_{oss}	--	15	--	
Reverse Transfer Capacitance		C_{rss}	--	9	--	
Turn-On Delay Time	$V_{DD} = -10V, I_D = -0.5A, V_{GS} = -4.5V, R_G = 6\Omega$	$T_{d(on)}$	--	7.2	--	nS
Rise Time		T_r	--	21	--	
Turn-Off Delay Time		$T_{d(off)}$	--	85	--	
Fall Time		T_f	--	116	--	
Total Gate Charge	$V_{DS} = -10V, V_{GS} = -4.5V, I_D = -0.5A$	Q_g	--	1.4	--	nC
Gate-Source Charge		Q_{gs}	--	0.19	--	
Gate-Drain Charge		Q_{gd}	--	0.2	--	
Drain-Source Body Diode	Conditions	Symbol	Min	Typ.	Max	Unit
Diode Forward Voltage	$I_S = -0.5A, V_{GS} = 0V$	V_{SD}	--	-0.93	-1.3	V
Maximum Continuous Drain-Source Forward Current	---	I_S	--	--	-0.5	A

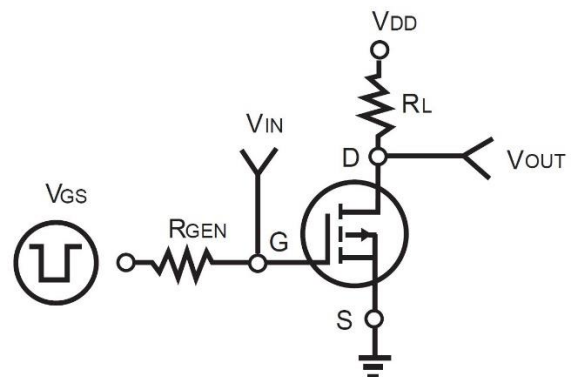
Note:

1. Pulse width $< 300\mu s$, Duty cycle $< 2\%$.
2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1-inch FR-4 with 2oz square pad of copper.
3. Guaranteed by design, not subject to production testing.
4. The maximum current rating is package limited.
5. Essential independent of operating temperature typical characteristics

Switching Time Waveform

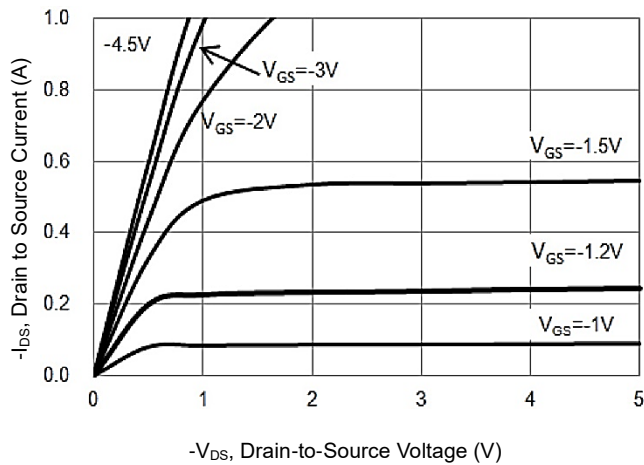


Switching Test Circuit

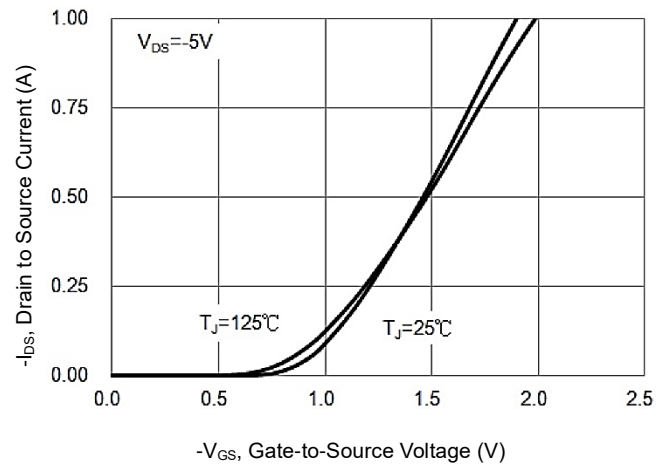


CHARACTERISTIC CURVES

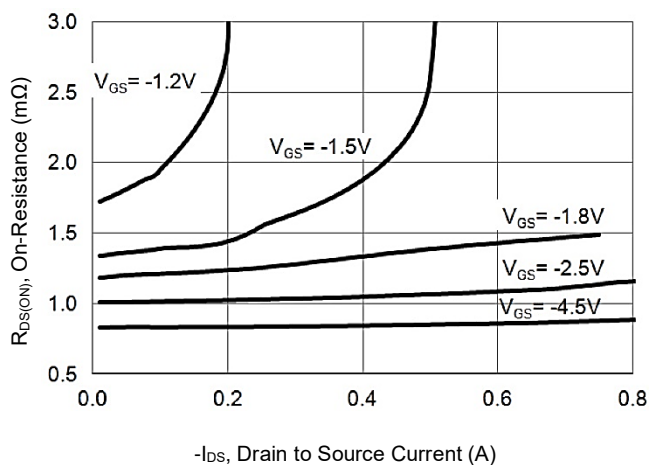
On Region Characteristics



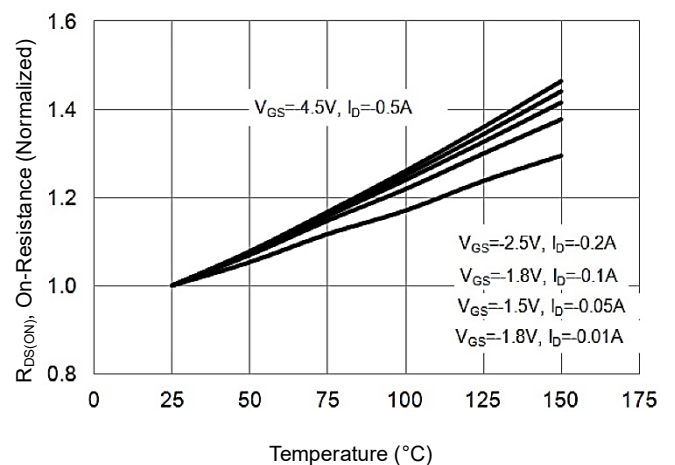
Transfer Characteristics



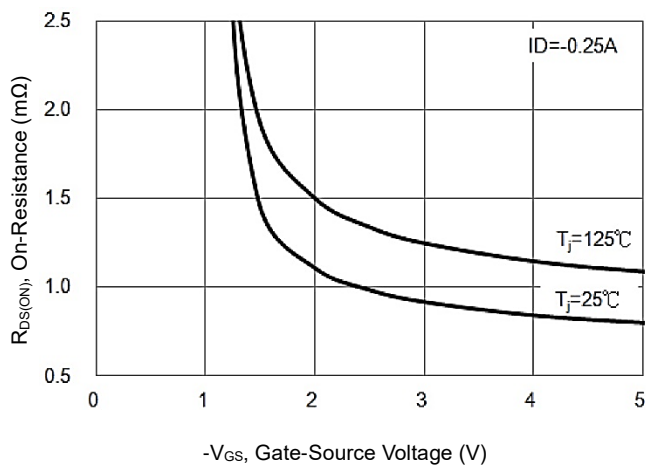
On-Resistance vs. Drain Current



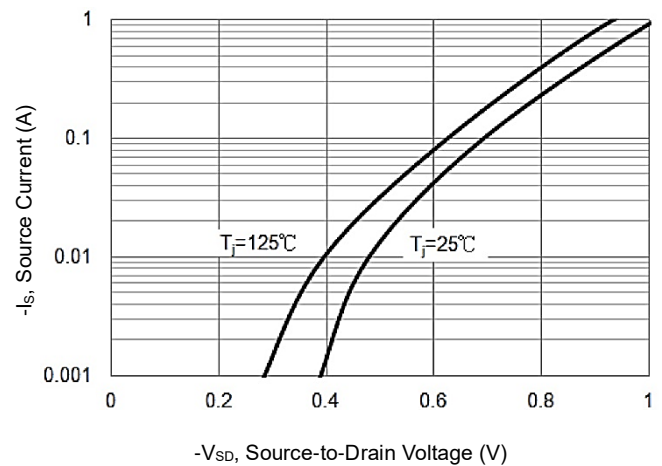
On-Resistance vs. Junction Temperature



On-Resistance Variation with V_{GS}



Body Diode Characteristics



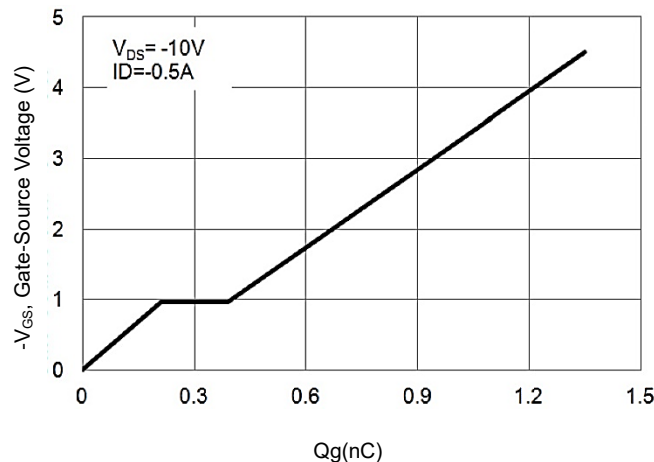
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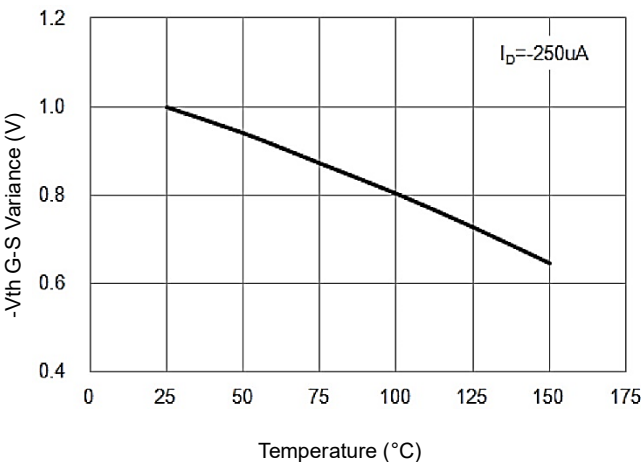
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CHARACTERISTIC CURVES

Gate Charge Characteristics



Threshold Voltage Variance vs. Temperature



Capacitance vs. Drain-Source Voltage

